up egalirent 153 BBA Swiss bit taker 4 days to send Look DONA data sheet for automotoine 153 BGA eMMC Milvon (VSS) (RFU) (NC) (NC) (NC) (NC) (NC (DATT) (NC) (NC) (NC) (NC) (NC) (NC) (NC) ( NC ) (DATE (VSSQ) (NC) (VCCQ) (NC) (NC) (NC) (NC) (NC) (NC D (RFU) (V<sub>CC</sub>) (V<sub>SS</sub>) (VSF1) (VSF2) ( NC ) ( NC )

Image of 153 BGA (Top View Ball Down)

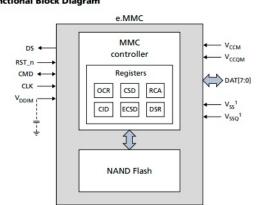
NC Not Connected
RFU reserved for future use

Vec , Veca West, and Vssa Board. Must Connect

system Board.

(RST\_n) (RFU) (RFU) (VSS) (VCC) (VSF6)

# Figure 7: e.MMC Functional Block Diagram



( NC ) ( NC

(NC) (NC) (NC) (NC) (NC) (NC) (NC)

(NC)(NC)(NC)(NC)(NC)(NC)

(VCCQ) (VSSQ) (NC) (NC) (NC) (NC) (NC)

Note: 1. V<sub>SS</sub> and V<sub>SSQ</sub> are internally connected.

1/17/2020 Notes eMMC change questions

Power rail
Parts added eMMC

Pins :

(NC) (NC) (NC)

(NC) (NC) (NC)

( NC ) ( NC )

I ( NC

( NC ) ( NC ) ( NC ) (VCCO) (CMD) (CLK)

1 ( NC

G

J

K

UHF Transever L Band only
Recieve on L Band prinon
UHF lister Backup

UN Requires Ablity to shot Love always

External Project RF Front end

Pin allocation for Swissbit e MMC adding to schematic

Removed SD Card Transister — mm( PWR Rasistor

Pins STM 32 F 446 x C/E

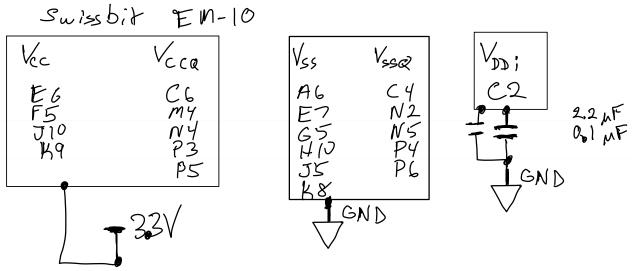
LQ FP64					
	Pin #	function		Pin Nan	~ L
26 27	34556639	00000000 1111111111 100000000000000000	DDDDDDDDDDDDDD	PC 8 (20) PB 0 (27) PB 1 PC 11 PB 8 PB 9 PC 7	(40) PC9 (51) PC 10
28	53 54		CK	(28) PB2 PD2	63) PC 12

Problems - Already in use

PBBC PC PC	OPD_SCI OPD_SDA RADTOI_CS RADTO2_CS
PD2	TP7

Team discussion
PD2 is Free
and just use DO D3
USP PC 13 if
Power control (on/off) is
needed

Wiring Notes using Swissbit\_AN\_EM-10\_RGL.pdf STM 32 F 446 X C/E Swissbit EN-10 Pin # Pin Name Pin # Junction Pin Name function SDIO SDIO SDIO SDIO SDIO SDIO SDIO DO DI PC 8 DATO BO DAT 1 PC9 DAT 2 DAT 3 D2 D3 D2 D3 PCIO PC 11 SDI6 SDI6 M6 M5 SDI6 CLK PC 12 CWD CK PDZ CMD MMC\_PWR PC 13



MMC\_PWR - Turn on/off cmmc Added 1

USE-EAGLE Commend "run length-freq-ri" to get longtha data
USE- Meander to change the length of the lines.

Make the length of the lines for SDIO\_DO-3 the Same

Made Changes to the U-Generic emm( library U-C3-.... library

Done to make wiving easier

Added library to Git

Talk to Rabin

1) Plan going forward with bound

• Move eMMC to last of M4

• Ranove Pin Hadar of unused plans

2) Get better undoustonding for signal line connections for eMMC

### 5.1 BGA 153 Ball Layout

The following figure provides the BGA layout recomme

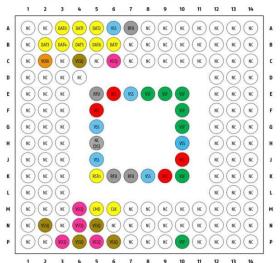


Figure 3: BGA Layout

Note: Do not connect the RFU and VSF balls. These are reserved for future use. VSF balls could be connected to test pads for debugging, especially:

P10: ROM Boot F10, G10, K10: Debug interface

NC (DS) pin is not used for EM-10 operation, but required by higher e.MMC standards

### 5.3 BGA 153 Ball Layout High Speed Signal Breakout Example

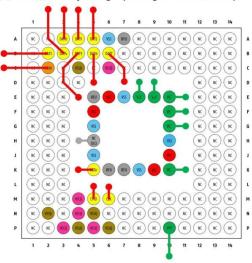


Figure 5: High Speed Example

Routing the high speed signals over a maximum of two no connect (NC) pins is allowed. To compensate for the different capacitive loading of the NC ball signals, use a shorter trace routing length. DS routing is not necessary for EM-10 but is suggested for compatibility with e.MMC5.x speed

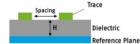
## 3.1 eMMC Signal Layout Guidelines

Signal routing should be implemented either in Microstrip line or Stripline as long as the trace impedance is maintained for all signals at 50 ohm ± 10%. See Figure 1 for the line definitions.

The suggested total signal trace lengths is <2000 mil.

The signal trace length skew constraints are as follows:

- ABS (CLK-DATo~DAT7): 250 mil
- ABS (CLK-CMD): 250 mil
- ABS (CLK-RST\_N): 1000 mil



The signal spacing constraints from other signals are:

- DATo~DAT7, CMD: > 2H
- RST\_N: > 1.5H

For these constraints, H is the height of the dielectric between signal and GND (reference layer).

Figure 1: Line Definitions

#### Recommendations for the signal branch include:

- Keep the signal trace branch lengths below 200 mil.
- Place the CLK test pad (if present) as close as possible to the eMMC package.

If there is enough space, it is recommended to use the GND (ground) shielding to reduce crosstalk effects between the eMMC signals.

